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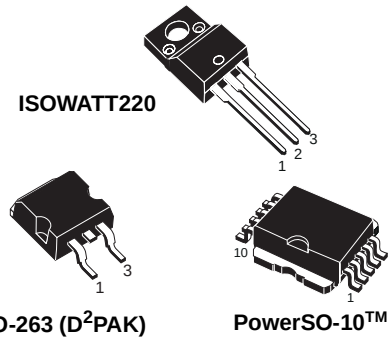
VNP49N04FI
VNB49N04 / VNV49N04

"OMNIFET": FULLY AUTOPROTECTED POWER MOSFET

TYPE	V_{CLAMP}	$R_{DS(ON)}$	I_{LIM}
VNP49N04FI VNB49N04 VNV49N04	42 V	20 mΩ	49 A

- LINEAR CURRENT LIMITATION
- THERMAL SHUT DOWN
- SHORT CIRCUIT PROTECTION
- INTEGRATED CLAMP
- LOW CURRENT DRAWN FROM INPUT PIN
- DIAGNOSTIC FEEDBACK THROUGH INPUT PIN
- ESD PROTECTION
- DIRECT ACCESS TO THE GATE OF THE POWER MOSFET (ANALOG DRIVING)
- COMPATIBLE WITH STANDARD POWER MOSFET



TO-263 (D^2PAK) **PowerSO-10™**

ORDER CODES:

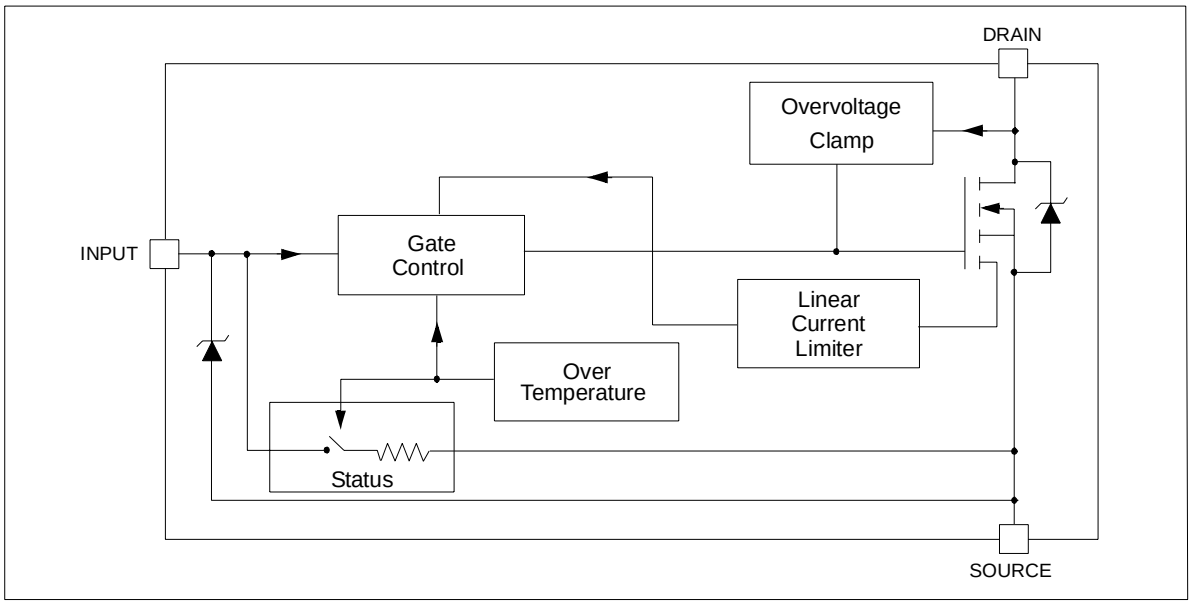
ISOWATT220	VNP49N04FI
PowerSO-10™	VNV49N04
TO-263 (D^2PAK)	VNB49N04

DESCRIPTION

The VNP49N04FI, VNB49N04, VNV49N04 are monolithic devices designed in STMicroelectronics VIPower M0 Technology, intended for replacement of standard Power MOSFETS from DC up to 50KHz applications. Built-in thermal shutdown, linear current limitation and overvoltage clamp protect the chip in harsh environments.

Fault feedback can be detected by monitoring the voltage at the input pin.

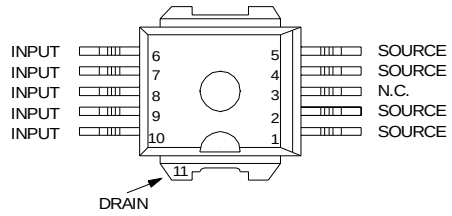
BLOCK DIAGRAM



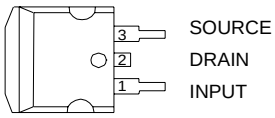
ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value			Unit
		PowerSO-10™	D²PAK	ISOWATT220	
V_{DS}	Drain-source Voltage (V_{IN}=0V)	Internally Clamped			V
V_{IN}	Input Voltage	18			V
I_D	Drain Current	Internally Limited			A
I_R	Reverse DC Output Current	-50			A
V_{ESD}	Electrostatic Discharge (R=1.5KΩ, C=100pF)	2000			V
P_{tot}	Total Dissipation at T_c=25°C	125	125	40	W
T_j	Operating Junction Temperature	Internally limited			°C
T_c	Case Operating Temperature	Internally limited			°C
T_{stg}	Storage Temperature	-55 to 150			°C

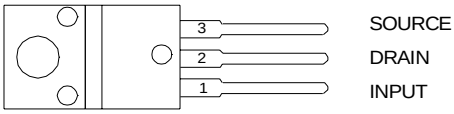
CONNECTION DIAGRAM (TOP VIEW)



PowerSO-10™



D²PAK



ISOWATT220

THERMAL DATA

Symbol	Parameter	Value			Unit
		PowerSO-10	D^2PAK	ISOWATT220	
$R_{thj\text{-}case}$	Thermal Resistance Junction-case MAX	1	1	3.12	°C/W
$R_{thj\text{-}amb}$	Thermal Resistance Junction-ambient MAX	50	62.5	62.5	°C/W

ELECTRICAL CHARACTERISTICS (-40°C < T_j < 125°C, unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{CLAMP}	Drain-source Clamp Voltage	I_D=200 mA; V_{IN}=0	34	42	50	V
V_{CLTH}	Drain-source Clamp Threshold Voltage	I_D=2mA; V_{IN}=0	33			V
V_{INCL}	Input-Source Reverse Clamp Voltage	I_{IN}= -1mA	-1.2		-0.1	V
I_{DSS}	Zero Input Voltage Drain Current (V_{IN}=0V)	V_{DS}=13V; V_{IN}=0V V_{DS}=25V; V_{IN}=0V			70 220	µA µA
I_{ISS}	Supply Current from Input Pin	V_{DS}=0V; V_{IN}=10V		250	550	µA

ON (*)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{IN(th)}$	Input Threshold Voltage	V_{DS}=$V_{IN;}$ I_D + I_{IN}=1mA	0.8		3	V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{IN}=10V; I_D=25A V_{IN}=5V; I_D=25A			0.04 0.05	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
g_{fs} (*)	Forward Transconductance	V_{DS}=13V; I_D=25A; T_c=25°C	25	30		S
C_{OSS}	Output Capacitance	V_{DS}=13V; f=1MHz; V_{IN}=0V; T_c=25°C		1100	1500	pF

SWITCHING (**)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=15V; I_D=25A V_{gen}=10V; R_{gen}=10 Ω (see figure 3)		200	600	ns
t_r	Rise Time			1300	3600	ns
$t_{d(off)}$	Turn-off Delay Time			800	2400	ns
t_f	Fall Time			300	900	ns
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=15V; I_D=25A V_{gen}=10V; R_{gen}=1000Ω (see figure 3)		1.3	3.8	µs
t_r	Rise Time			3.8	10.4	µs
$t_{d(off)}$	Turn-off Delay Time			12	24	µs
t_f	Fall Time			6.1	17	µs
$(di/dt)_{on}$	Turn-on Current Slope	V_{DS}=15V; I_D=25A V_{IN}=10V; R_{gen}=10 Ω		25		A/µs
Q_i	Total Input Charge	V_{DS}=15V; I_D=25A; V_{IN}=10V		100		nC

SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{SD} (*)	Forward On Voltage	I_{SD}=25A; V_{IN}=0V			1.8	V
t_{rr} (**)	Reverse Recovery Time	I_{SD}=25A; di/dt=100A/µs		250		ns
Q_{rr} (**)	Reverse Recovery Charge	V_{DS}=30V; T_j=25°C		910		nC
I_{RRM} (**)	Reverse Recovery Current	(see test circuit, figure 5)		7.5		A

PROTECTIONS

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I_{LIM}	Drain Current Limit	V_{IN}=10V; V_{DS}=13V	28	49	70	A
		V_{IN}=5V; V_{DS}=13V	28	49	70	A
t_{dlim} (**)	Step Response Current Limit	V_{IN}=10V		35	50	µs
		V_{IN}=5V		90	150	µs
T_{jsh} (**)	Overtemperature Shutdown		150			°C
T_{jrs} (**)	Overtemperature Reset		135			°C
I_{gf} (**)	Fault Sink Current	V_{IN}=10V; V_{DS}=13V		50		mA
		V_{IN}=5V; V_{DS}=13V		20		mA
E_{as} (**)	Single Pulse Avalanche Energy	Starting T_j=25°C; V_{DS}=20V V_{IN}=10V; R_{gen}=1KΩ; L=6mH	4			J

(*) Pulsed: Pulse duration = 300µs, duty cycle 1.5%
(**) Parameters guaranteed by design/characterization

PROTECTION FEATURES

During normal operation, the INPUT pin is electrically connected to the gate of the internal power MOSFET. The device then behaves like a standard power MOSFET and can be used as a switch from DC up to 50KHz. The only difference from the user's standpoint is that a small DC current (I_{ISS}) flows into the INPUT pin in order to supply the internal circuitry.

The device integrates:

- OVERVOLTAGE CLAMP PROTECTION:

internally set at 42V, along with the rugged avalanche characteristics of the Power MOSFET stage give this device unrivalled ruggedness and energy handling capability. This feature is mainly important when driving inductive loads.

- LINEAR CURRENT LIMITER CIRCUIT:

limits the drain current I_D to I_{LIM} whatever the INPUT pin voltage. When the current limiter is active, the device operates in the linear region, so power dissipation may exceed the capability of the heatsink. Both case and junction temperatures increase, and if this phase lasts long enough, junction temperature may reach the overtemperature threshold T_{jsh}.

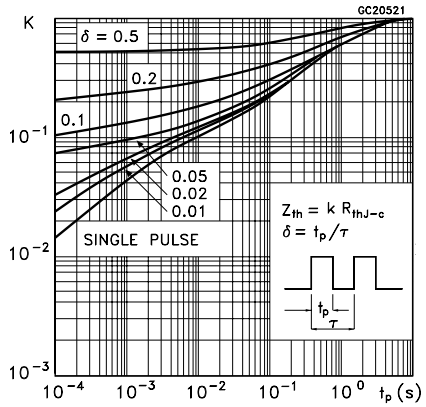
- OVERTEMPERATURE AND SHORT CIRCUIT PROTECTION:

these are based on sensing the chip temperature and are not dependent on the input voltage. The location of the sensing element on the chip in the power stage area ensures fast, accurate detection of the junction temperature. Overtemperature cutout occurs at minimum 150°C. The device is automatically restarted when the chip temperature falls below 135°C.

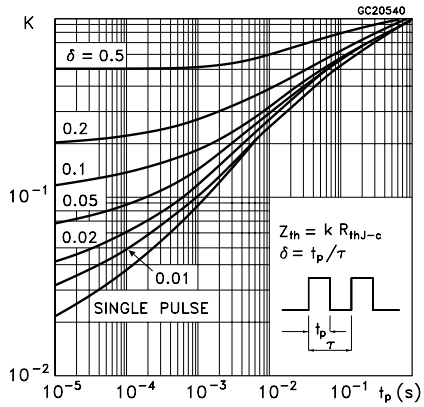
- STATUS FEEDBACK:

in the case of an overtemperature fault condition, a status feedback is provided through the INPUT pin. The internal protection circuit disconnects the input from the gate and connects it instead to ground via an equivalent resistance of 100Ω. The failure can be detected by monitoring the voltage at the INPUT pin, which will be close to ground potential. Additional features of this device are ESD protection according to the Human Body model and the ability to be driven from a TTL Logic circuit (with a small increase in $R_{DS(ON)}$).

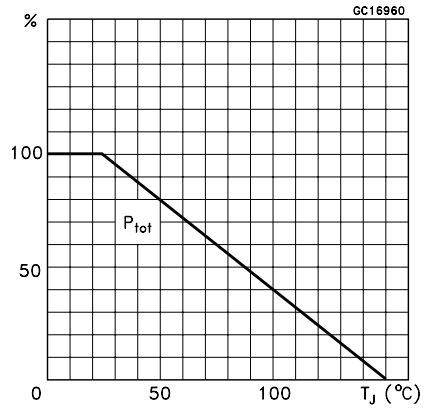
Thermal Impedance for ISOWATT220



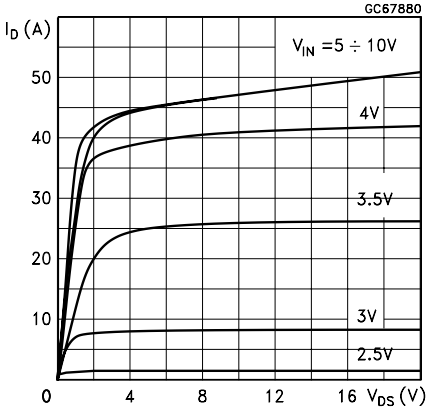
Thermal Impedance for D2PAK / PowerSO-10



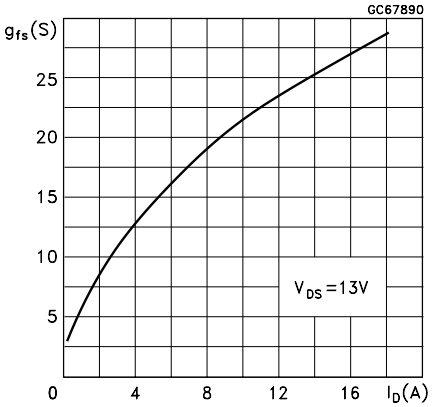
Derating Curve



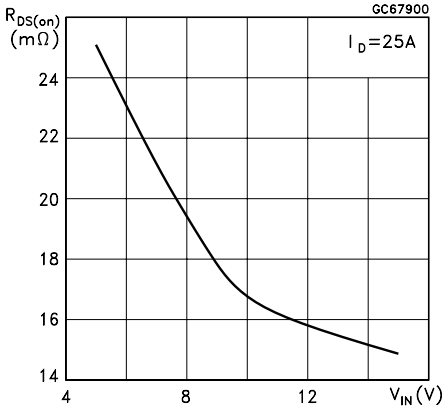
Output Characteristics



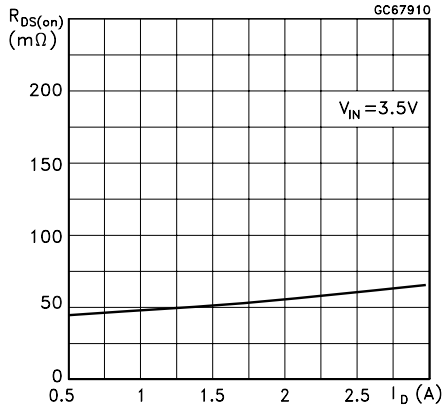
Transconductance



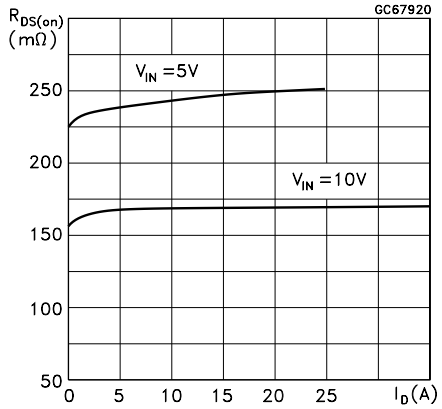
Static Drain-Source On Resistance vs Input Voltage



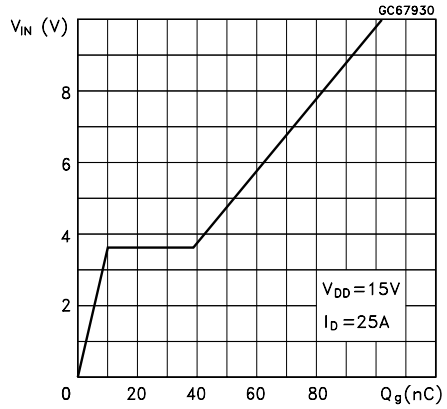
Static Drain-Source On Resistance



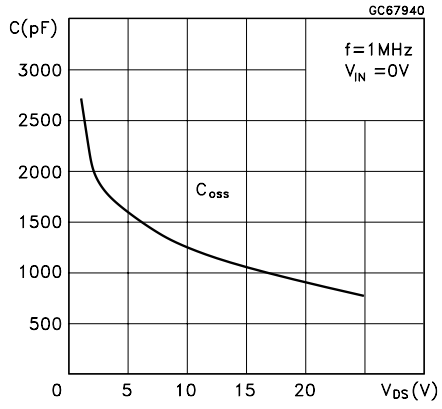
Static Drain-Source On Resistance



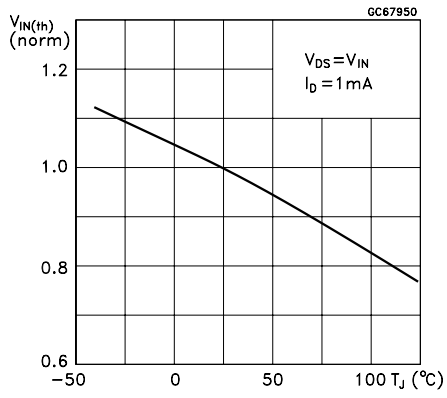
Input Charge vs Input Voltage



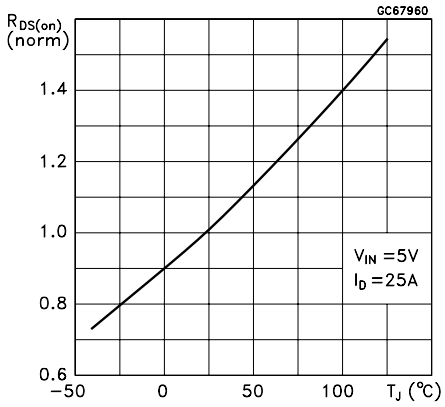
Capacitance Variations



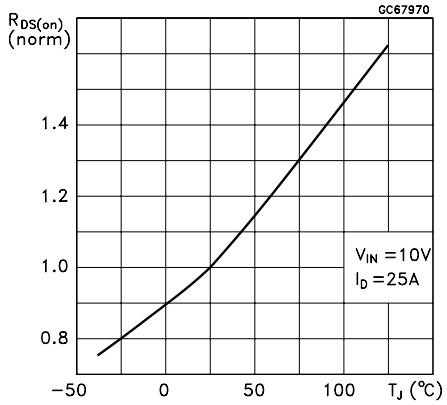
Normalized Input Threshold Voltage vs Temperature



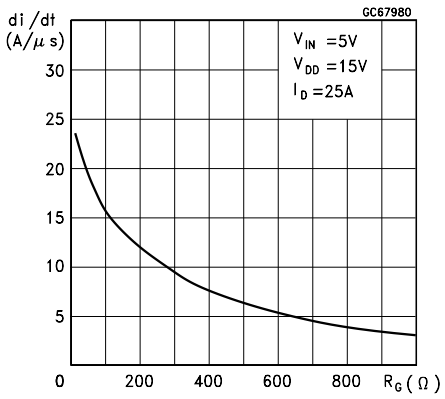
Normalized On Resistance vs. Temperature



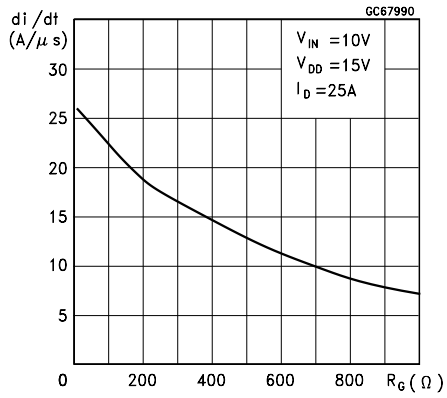
Normalized On Resistance vs. Temperature



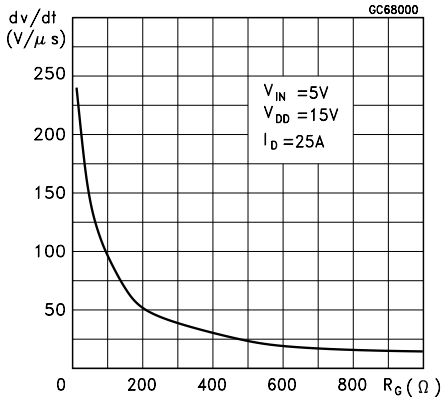
Turn-on Current Slope



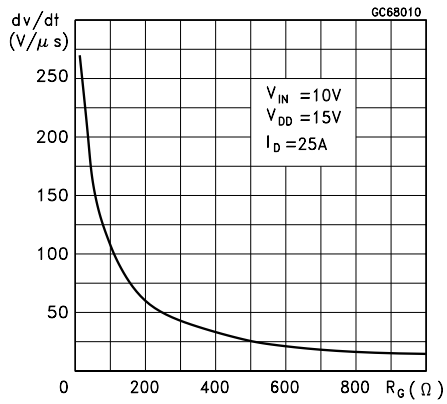
Turn-on Current Slope



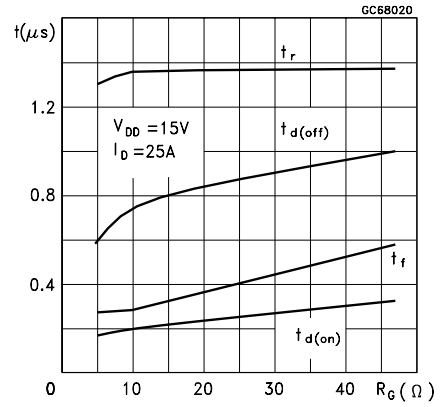
Turn-off Drain-Source Voltage Slope



Turn-off Drain-Source Voltage Slope



Switching Time Resistive Load



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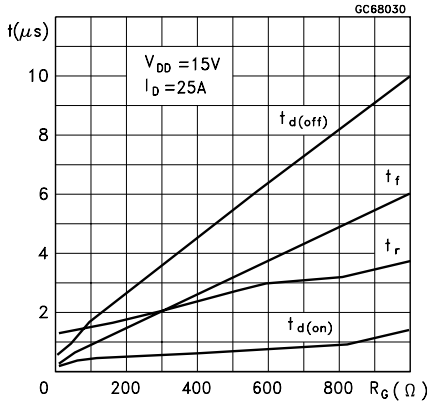
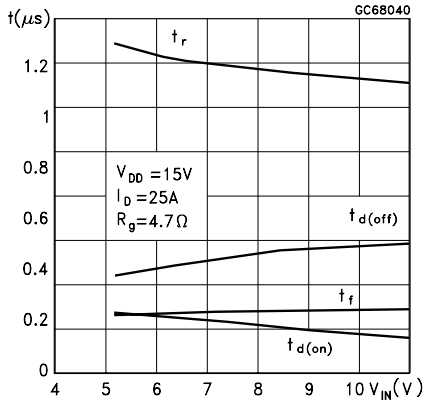
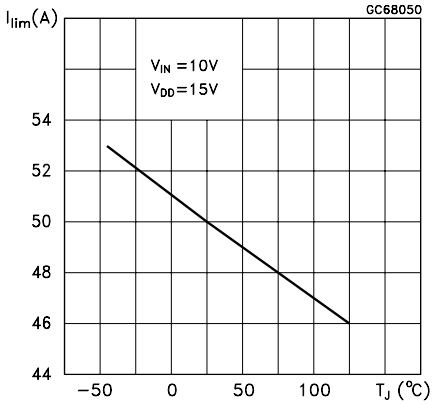


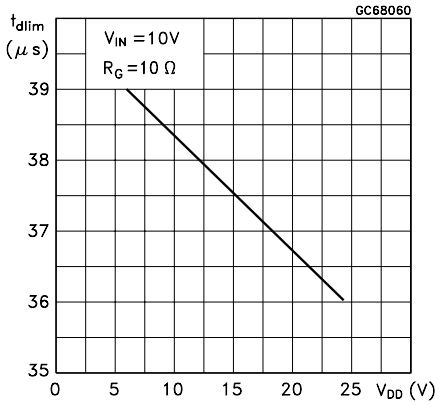
Switching Time Resistive Load



Current Limit vs. Junction Temperature



Step Response Current Limit



Source Drain Diode Forward Characteristics

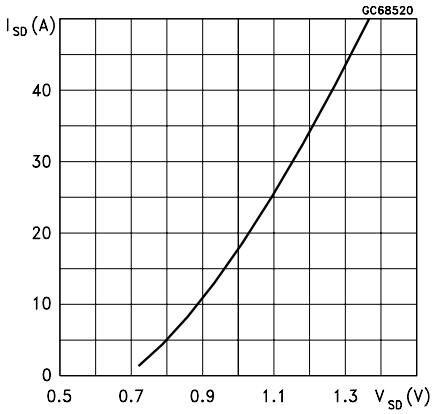


Figure 1: Unclamped Inductive Load Test Circuits

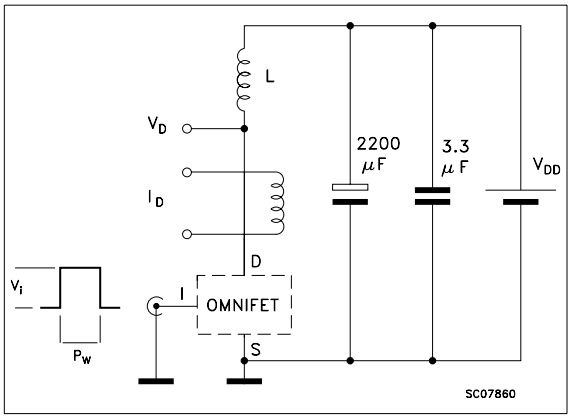


Figure 2: Unclamped Inductive Waveforms

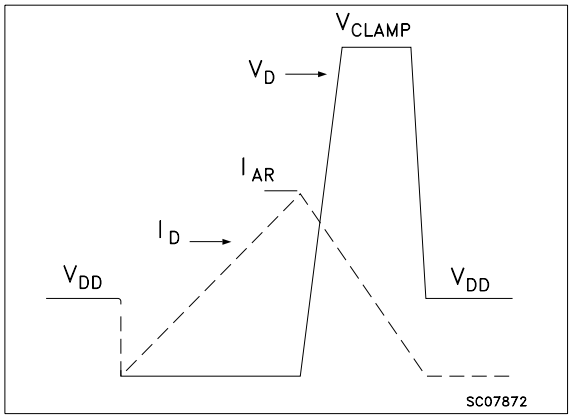


Figure 3: Switching Time Test Circuits for Resistive Load

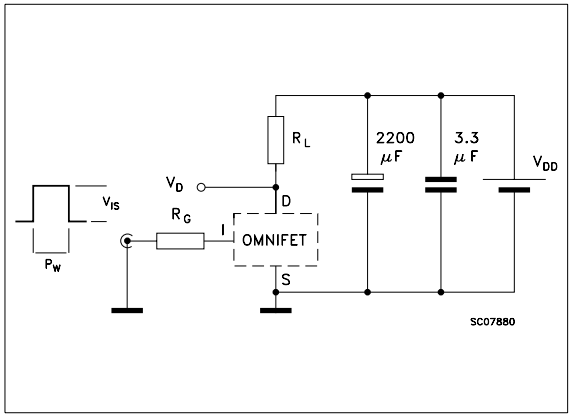


Figure 4: Input Charge Test Circuit

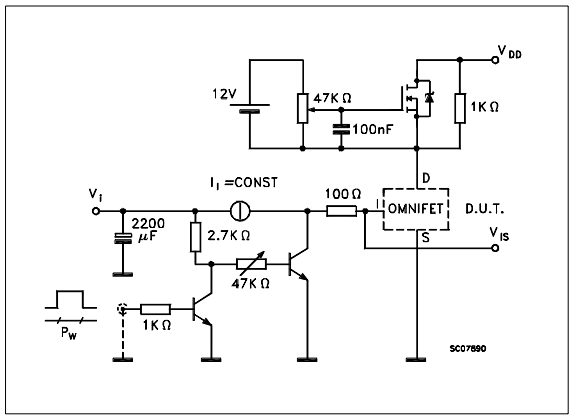


Figure 5: Test Circuit for Inductive Load Switching and Diode Recovery Times

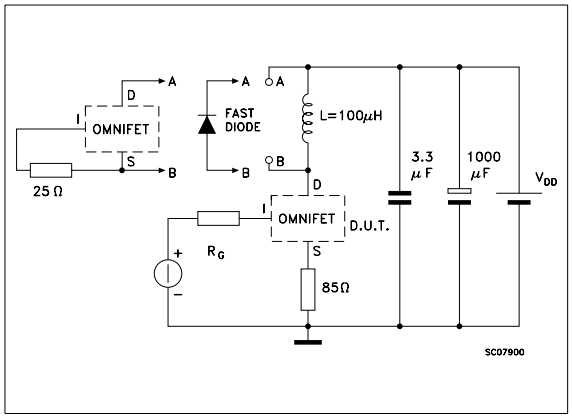
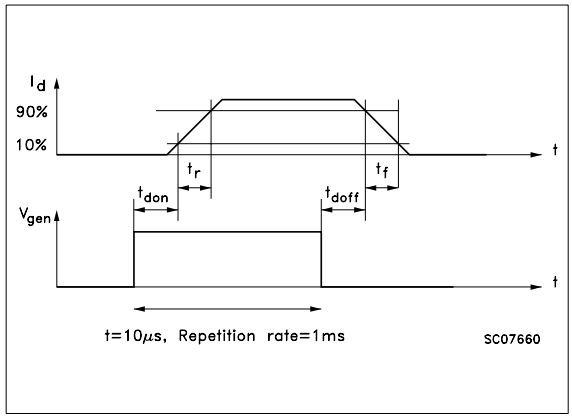
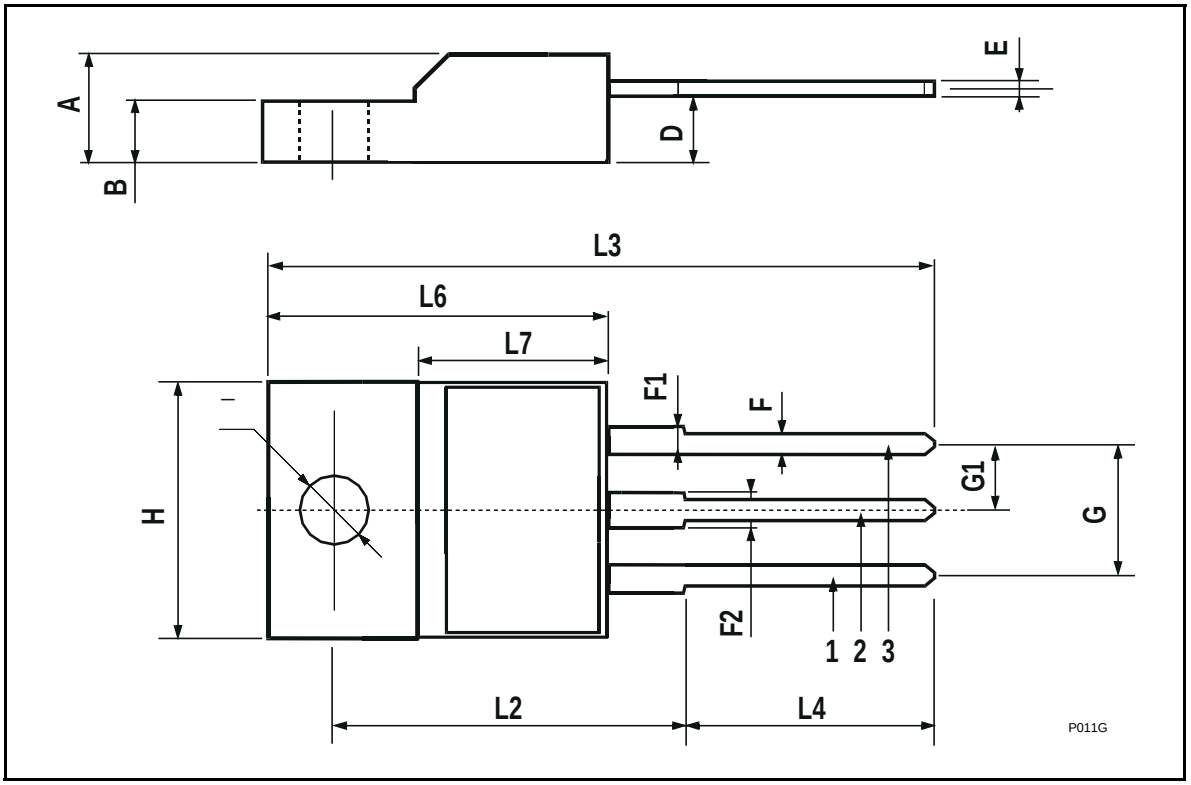


Figure 6: Waveforms



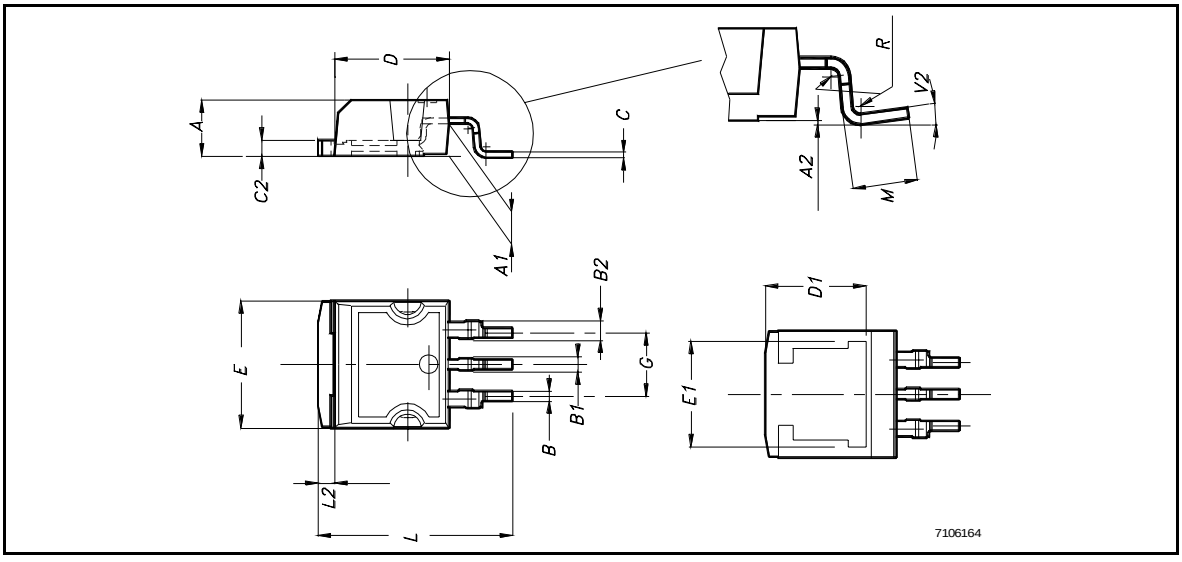
ISOWATT220 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.4		0.7	0.015		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
H	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
	3		3.2	0.118		0.126



D^2PAK MECHANICAL DATA

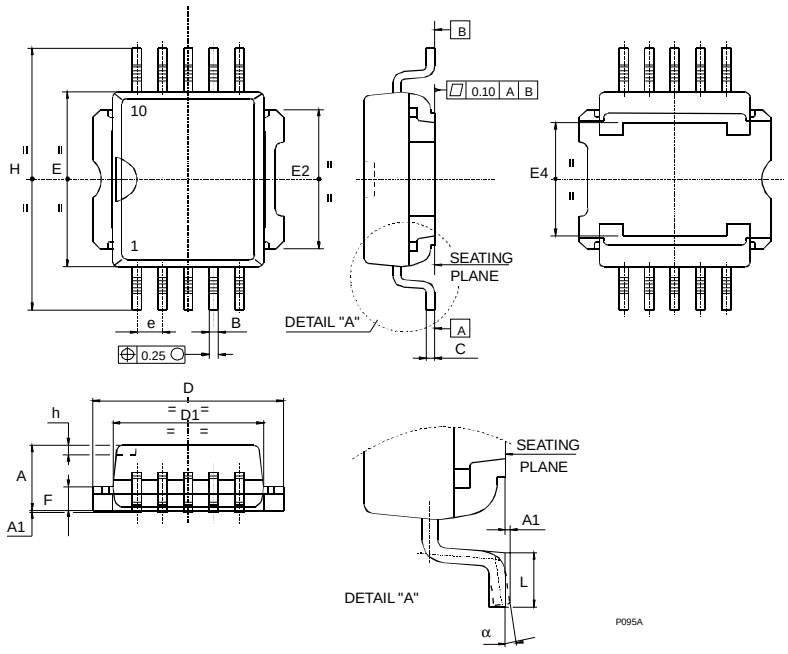
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.7		0.93	0.027		0.036
B1	0.8		1.3	0.031		0.051
B2	1.14		1.7	0.044		0.067
C	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8			0.315	
E	10		10.4	0.393		
E1		8.5			0.334	
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.625
L2	1.27		1.4	0.050		0.055
M	2.4		3.2	0.094		0.126
R		0.4			0.015	
V2	0º		8º			



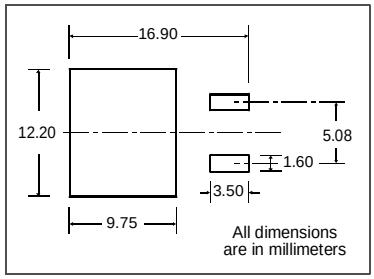
PowerSO-10™ MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	3.35		3.65	0.132		0.144
A (*)	3.4		3.6	0.134		0.142
A1	0.00		0.10	0.000		0.004
B	0.40		0.60	0.016		0.024
B (*)	0.37		0.53	0.014		0.021
C	0.35		0.55	0.013		0.022
C (*)	0.23		0.32	0.009		0.0126
D	9.40		9.60	0.370		0.378
D1	7.40		7.60	0.291		0.300
E	9.30		9.50	0.366		0.374
E2	7.20		7.60	0.283		300
E2 (*)	7.30		7.50	0.287		0.295
E4	5.90		6.10	0.232		0.240
E4 (*)	5.90		6.30	0.232		0.248
e		1.27			0.050	
F	1.25		1.35	0.049		0.053
F (*)	1.20		1.40	0.047		0.055
H	13.80		14.40	0.543		0.567
H (*)	13.85		14.35	0.545		0.565
h		0.50			0.002	
L	1.20		1.80	0.047		0.070
L (*)	0.80		1.10	0.031		0.043
α	0º		8º	0º		8º
α (*)	2º		8º	2º		8º

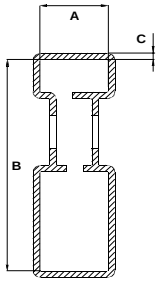
(*) Muar only POA P013P



D^2PAK FOOTPRINT



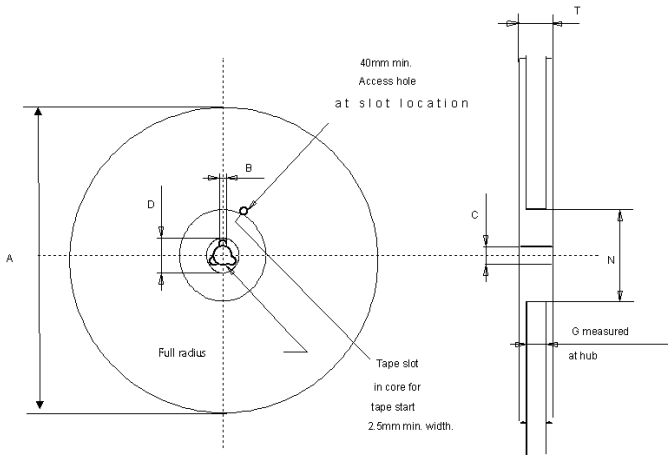
TUBE SHIPMENT (no suffix)



Base Q.ty	50
Bulk Q.ty	500
Tube length (± 0.5)	532
A	6
B	21.3
C (± 0.1)	0.6

All dimensions are in mm.

TAPE AND REEL SHIPMENT (suffix "13TR")



REEL DIMENSIONS

Base Q.ty	1000
Bulk Q.ty	1000
A (max)	330
B (min)	1.5
C (± 0.2)	13
F	20.2
G (+ 2 / -0)	24.4
N (min)	60
T (max)	30.4

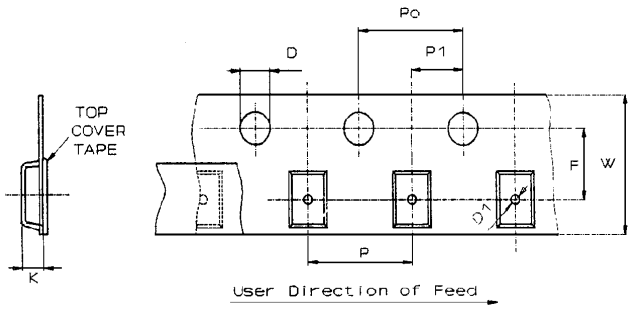
All dimensions are in mm.

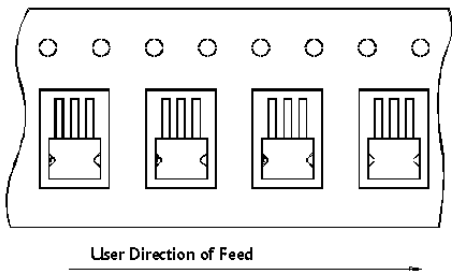
TAPE DIMENSIONS

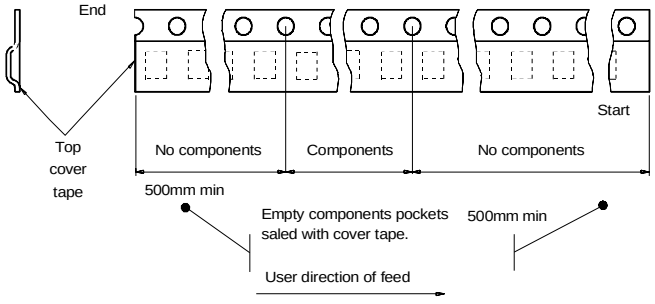
According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb. 1986

Tape width	**W**	24
Tape Hole Spacing	**P0 (± 0.1)**	4
Component Spacing	**P**	16
Hole Diameter	**D (± 0.1/-0)**	1.5
Hole Diameter	**D1 (min)**	1.5
Hole Position	**F (± 0.05)**	11.5
Compartment Depth	**K (max)**	6.5
Hole Spacing	**P1 (± 0.1)**	2

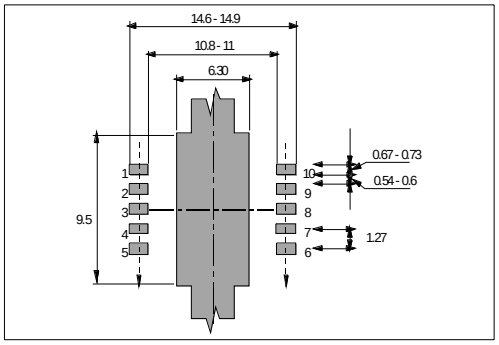
All dimensions are in mm.



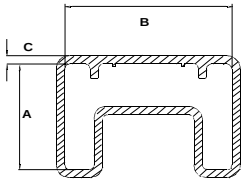




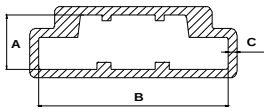
PowerSO-10™ SUGGESTED PAD LAYOUT



TUBE SHIPMENT (no suffix)



CASABLANCA

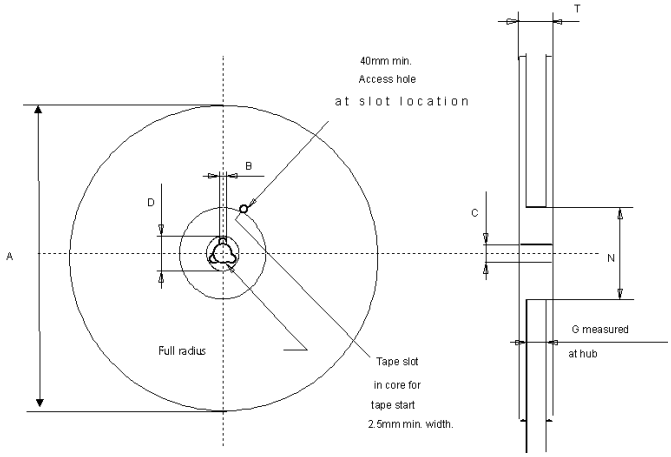


MUAR

All dimensions are in mm.

	Base Q.ty	Bulk Q.ty	Tube length (± 0.5)	A	B	C (± 0.1)
Casablanca	50	1000	532	10.4	16.4	0.8
Muar	50	1000	532	4.9	17.2	0.8

TAPE AND REEL SHIPMENT (suffix "13TR")



REEL DIMENSIONS

Base Q.ty	600
Bulk Q.ty	600
A (max)	330
B (min)	1.5
C (± 0.2)	13
F	20.2
G (+ 2 / -0)	24.4
N (min)	60
T (max)	30.4

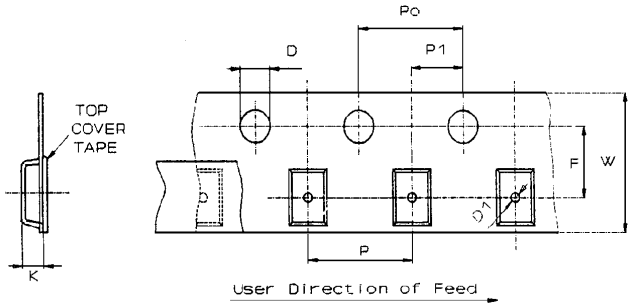
All dimensions are in mm.

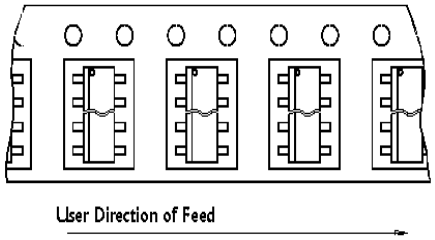
TAPE DIMENSIONS

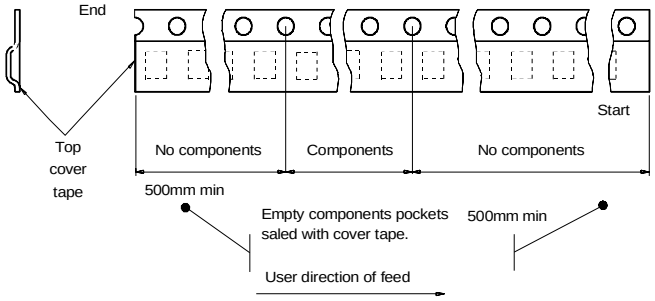
According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb. 1986

Tape width	**W**	24
Tape Hole Spacing	**P0 (± 0.1)**	4
Component Spacing	**P**	24
Hole Diameter	**D (± 0.1/-0)**	1.5
Hole Diameter	**D1 (min.)**	1.5
Hole Position	**F (± 0.05)**	11.5
Compartment Depth	**K (max)**	6.5
Hole Spacing	**P1 (± 0.1)**	2

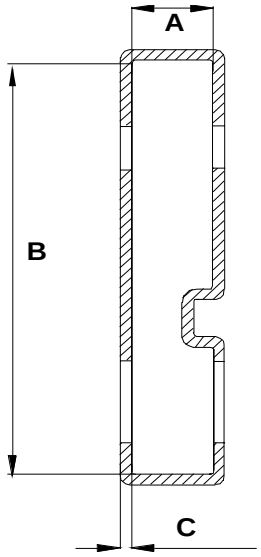
All dimensions are in mm.







ISOWATT220 TUBE SHIPMENT (no suffix)



Base Q.ty	50
Bulk Q.ty	1000
Tube length (± 0.5)	532
A	5.5
B	31.4
C (± 0.1)	0.75

All dimensions are in mm.